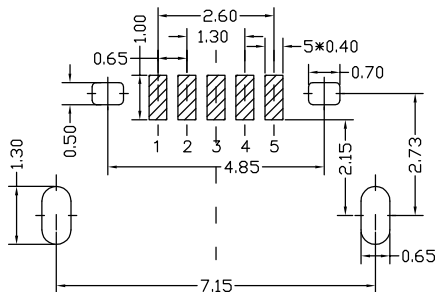
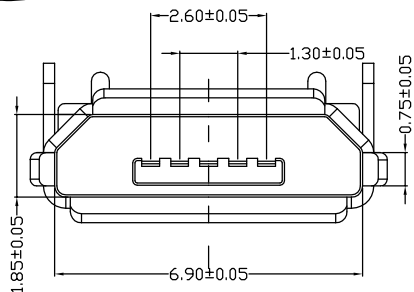


The product using material and processing must conform to the "WL-PZ-001"HSF technical standard control requirements

RoHS



RECOMMENDED PCB LAYOUT

NOTE:

- 1.MATERIAL SPECIFICATION:
 - 1-1.HOUSING:LCP BLACK UL94V-0
 - 1-2.CONTACTS:COPPER ALLOY.
 - 1-3.SHELL: STAINLESS STEEL.
- 2.PLATING SPECIFICATION:
 - 2-1.CONTACTS:
 - Ni 50u" MIN. UNDER PLATED OVER ALL.
 - Au PLATED ON THE FUNCTIONAL AREA OF CONTACT.
 - 2-2. SHELL:
 - Ni OR SN UNDER PLATED OVER ALL.
- 3.MECHANICAL PERFORMANCE:
 - 3-1.INSERTION FORCE: 3.57kgf MAX
 - 3-2.REMOVAL FORCE: 0.8kgf MIN
 - 3-3.DURABILITY: 10000 CYCLES.
- 4.ELECTRICAL PERFORMANCE:
 - 4-1.CURRENT RATING:1.5A
 - 4-2.VOLTAGE RATING:5V MAX
 - 4-3.CONTACT RESISTANCE: 30m Ohm MAX.
 - 4-4.INSULATION RESISTANCE: 100MΩ MIN
 - 4-5.DIELECTRIC WITHSTANDING VOLTAGE: 100V AC MIN
- 5.ENVIRONMENTAL PERFORMANCE:
 - OPERATING TEMPERATURE: -30°C~+85°C.
- 6.PACKAGE SPEC: REEL

PART NO.:

WLM2F9-05 2 X X X 079

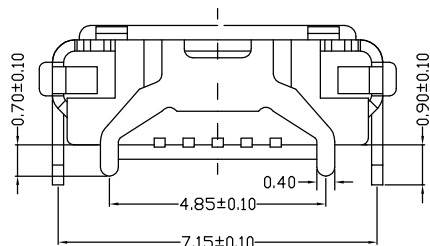
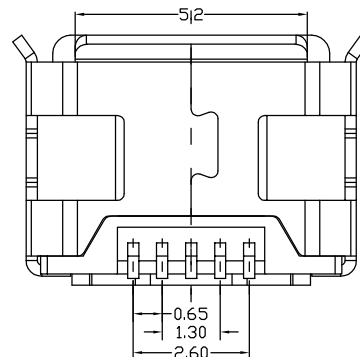
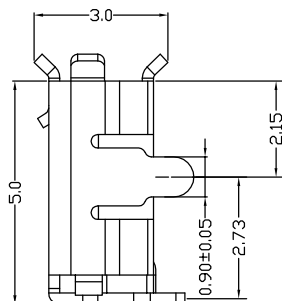
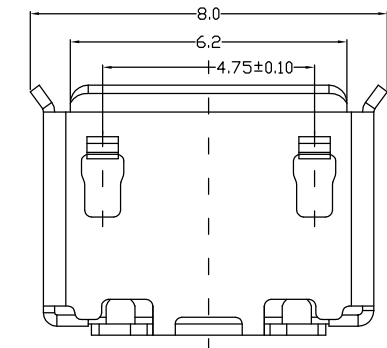
PLATING:

- 1-G/F
- 2-Au 3u"
- 5-Au 15u"
- 6-Au 30u"

SHELL:

- 7-SN
- 9-NI

COLOUR:
A-BLACK



REV.	REVISION RECORD	DATE		GENERAL TOLERANCES		SCALE: 1:1	NAME	DATE	PART.NO: WLM2F9-052XXX079	DWG.NO: ENDE05	
A0	NEW RELEASE	21.01.13		LINEAR	ANGLES	APPROVED	Wang_jr	21.01.13			
			0.00±0.35	X°REF±6'	DESIGNER	Ding_bo	21.01.13	TITLE: MICRO 5P/F B TYPE DIP 0.9(7.15*4.85)			
			UNIT:mm	0.00±0.25	X'±3'	DRAWN	Ou_jian		21.01.13		
			SIZE: A4	0.000±0.10	X'X' ±2'				REV: A0	SHEET: 1/1	